

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application:

1. (original) A curable liquid composition comprising:

(A) particles including an oxide of at least one element selected from the group consisting of indium, antimony, zinc, and tin as a major component,

(B) a compound having at least two polymerizable unsaturated groups in the molecule,

(C) a solvent in which solubility of the component (B) is less than 10 wt%, and

(D) a solvent in which solubility of the component (B) is 10 wt% or more, the components (A) and (B) being uniformly dispersed or dissolved in the composition.

2 (original) The curable liquid composition according to claim 1, further comprising (E) a photoinitiator.

3. (currently amended) The curable liquid composition according to claim 1 or 2, wherein the component (A) is particles including either antimony-doped tin oxide (ATO) or tin-doped indium oxide (ITO) as a major component.

4. (currently amended) The curable liquid composition according to ~~any of claims 1 to 3~~ claim 1, wherein the component (A) is oxide particles surface-treated by using a surface treatment agent.

5. (original) The curable liquid composition according to claim 4, wherein the surface treatment agent is a compound including at least two polymerizable unsaturated groups, a group shown by the following formula (1),



wherein X represents NH, O (oxygen atom), or S (sulfur atom), and Y represents O or S, and a silanol group or a group which forms a silanol group by hydrolysis.

6. (original) The curable liquid composition according to claim 5, wherein the group shown by the formula (1) is at least one group selected from the group consisting of -O-C(=O)-NH-, -O-C(=S)-NH-, and -S-C(=O)-NH-.

7. (currently amended) The curable liquid composition according to ~~any of claims 1 to 6~~ claim 1, wherein the component (C) is water, the content of water in the total solvent in the composition being 0.1-50 wt%.

8. (currently amended) The curable liquid composition according to ~~any of claims 1 to 6~~ claim 1, wherein the component (C) is an organic solvent, the content of the organic solvent in the total solvent in the composition being 5-95 wt%.

9. (currently amended) The curable liquid composition according to ~~any one of claims 1-8~~ claim 1, wherein the solid content of the composition is at least 50%.

10. (currently amended) A cured film obtained by curing the curable liquid composition according to ~~any of claims 1 to 8~~ claim 1, the cured film having surface resistivity of $1 \times 10^{12} \Omega/\square$ or less.

11. (currently amended) A process for producing a cured film, comprising a step of curing the curable liquid composition according to ~~any of claims 1 to 8~~ claim 1 by applying radiation to the composition.

12. (currently amended) An antistatic laminate comprising a layer of a cured film obtained by curing the curable liquid composition according to ~~any of claims 1 to 8~~ claim 1.

13. (original) The antistatic laminate according to claim 11, wherein the thickness of the layer of the cured film is 0.1-20 μ m.